



Fanless Embedded System



## Specifications :

■ <b>Dimension (W*H*D)</b>	■ 185 * 48 * 142 mm
■ <b>Construction</b>	■ Aluminum housing
■ <b>System model</b>	■ HBJC376C55-2930-B ■ HBJC376C55W-2930-B
■ <b>MB model</b>	■ JNC55-E2930-2G
■ <b>CPU</b>	■ INTEL® Bay Trail-M N2930 SoC Processor (1.86GHz)
■ <b>BIOS</b>	■ AMI UEFI
■ <b>Memory</b>	■ Onboard SAMSUNG 2G/1333MHz DDR3L Memory
■ <b>Storage Space</b>	■ 1 * 2.5" SATA Device (Max Height 9.5 mm) ■ 1 * m-SATA SSD Device (Mini PCI-E)
■ <b>Display Interface</b>	■ 1 * HDMI ■ 1 * VGA
■ <b>Network</b>	■ 2 * RJ45 (Giga Lan) ■ WiFi (HBJC376C55W-2930-B only)
■ <b>Audio</b>	■ 1 * Line out ■ 1 * Mic in
■ <b>Front I/O Port</b>	■ 5 * USB 2.0 , 1 * USB 3.0 ■ 1 * Speaker con ( R+/R-/L+/L- )
■ <b>Rear I/O Port</b>	■ 6 * COM (COM5/COM6 Support RS232/422/485) , 1 * GPIO
■ <b>Expansion Interface</b>	■ 1 * Mini PCI-E (Full-size)
■ <b>Power Source</b>	■ DC 9~24V Jack input ■ Adapter : AC_90~240V / DC_12V_5A / 60W
■ <b>Certification</b>	■ EMC : CE , FCC ■ Safety : RoHS , ErP
■ <b>Environment</b>	■ Operating Temperature : 0 ~ 50°C ■ Storage Temperature : -10 ~ 70°C
■ <b>Mounting</b>	■ Wall mounting Kits

■ **Packing**

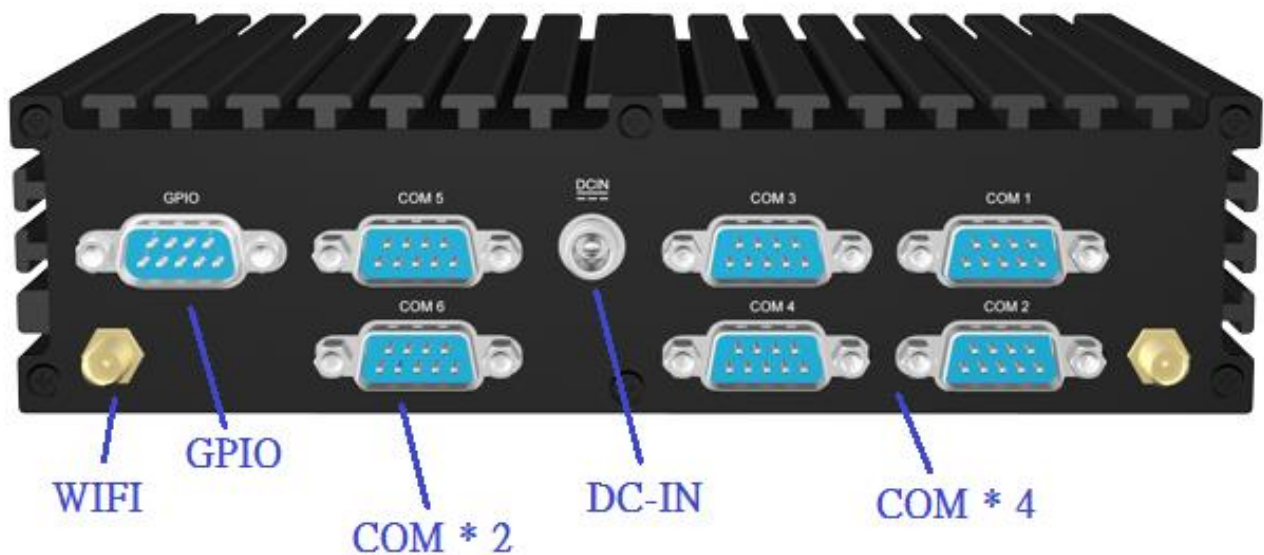
- Net Weight : 1.4KG
- Gross Weight : 2.7KG
- Color Box Dimension : 250(W) x 118 (D) x 295 (H) mm

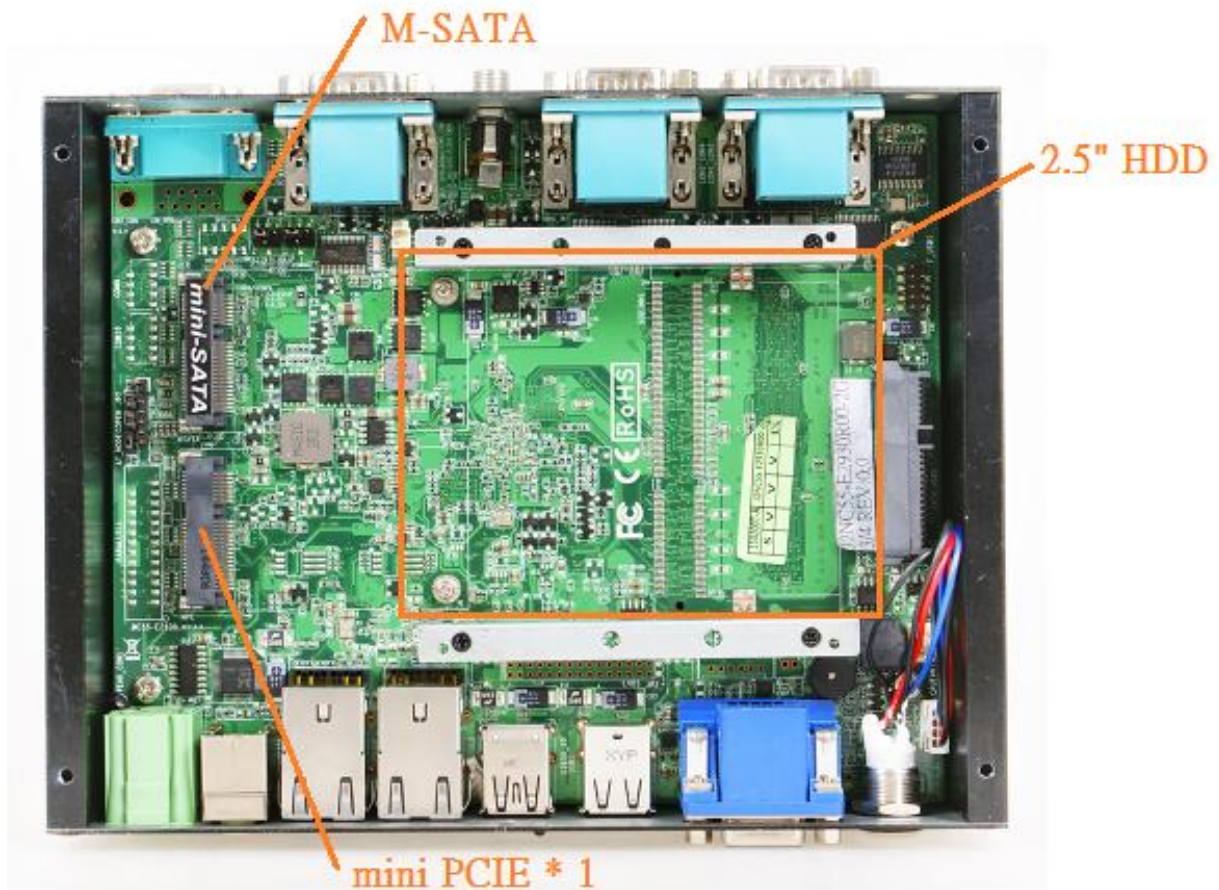
**External I/O :**

**Fornt**



**Rear**





### Packing List :

Parts Number	Description
— — —	HBJC376C55(W)-2930-B
L01AS036-F	Adapter 12V/5A 60W
Change according to shipping area	Power cord
HCS3XXDINRAILPS-F	DIN RAIL
LCSC HBJC3XX-F	HBJC350&HBJC36X&HBJC37X Screw Pack